

About Omics Group

[OMICS Group](#) International through its Open Access Initiative is committed to make genuine and reliable contributions to the scientific community. [OMICS Group](#) hosts over 400 leading-edge peer reviewed Open Access Journals and organize over 300 International Conferences annually all over the world. OMICS Publishing Group journals have over 3 million readers and the fame and success of the same can be attributed to the strong editorial board which contains over 30000 eminent personalities that ensure a rapid, quality and quick review process.

About Omics Group conferences

- [OMICS Group](#) signed an agreement with more than 1000 International Societies to make healthcare information Open Access. [OMICS Group](#) Conferences make the perfect platform for global networking as it brings together renowned speakers and scientists across the globe to a most exciting and memorable scientific event filled with much enlightening interactive sessions, world class exhibitions and poster presentations
- Omics group has organised 500 conferences, workshops and national symposium across the major cities including San Francisco, Omaha, Orlando, Raleigh, Santa Clara, Chicago, Philadelphia, United Kingdom, Baltimore, San Antonio, Dubai, Hyderabad, Bangaluru and Mumbai.

$p \leftrightarrow n$ - Transverse Thermoelectrics: A new class of Materials with Possible Optoelectronic Applications

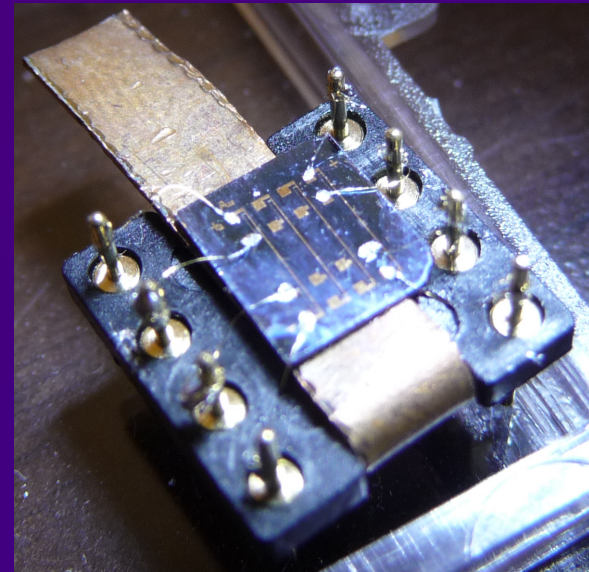
Matthew Grayson

m-grayson@northwestern.edu
EECS, Northwestern U.

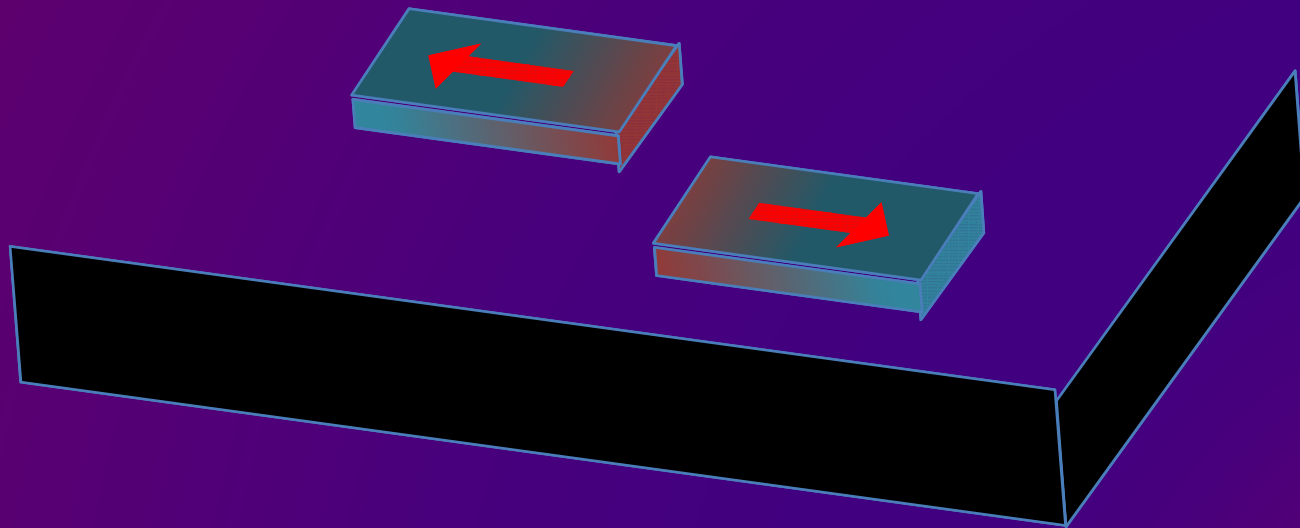


Chuanle Zhou (post-doc), Boya Cui, Yang Tang (PhD)
Stefan Birner (NextNano / TU Munich)
Karen Heinselman
Phys. Rev. Lett. 110, 227701 (2013)

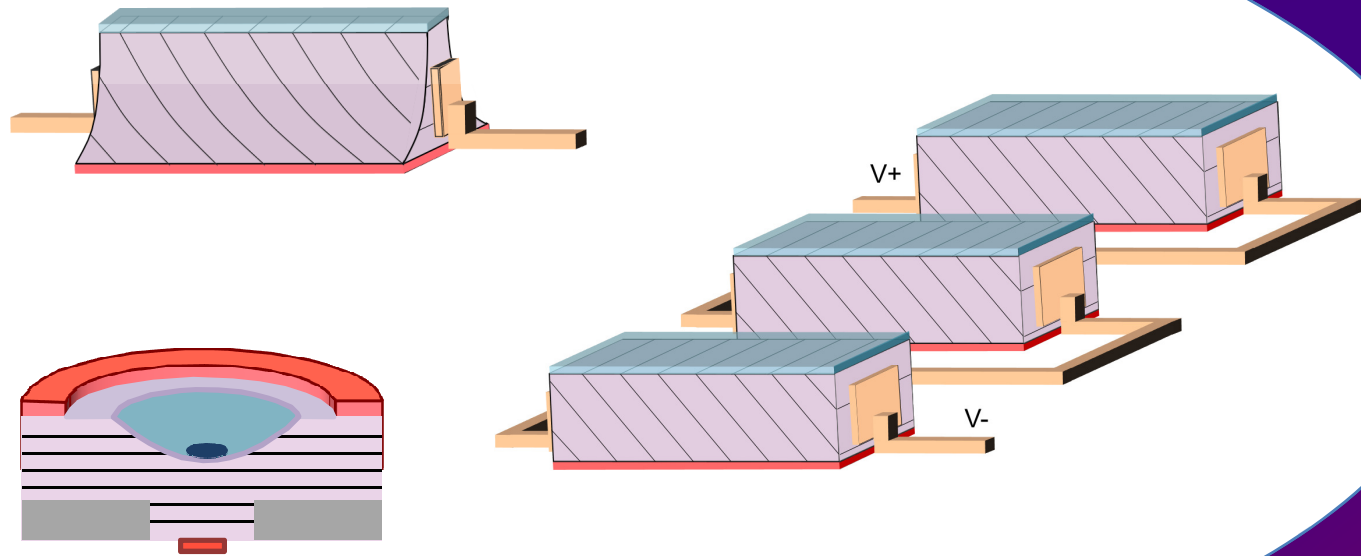
Motivation #1: for *intrinsic* on-chip cryocooling



Motivation #2: integrated thermal management



Motivation #3: overcome ZT limitations with geometric shaping



$p \times n$ Transverse Thermoelectrics:

Outline:

I. Transverse Thermoelectricity

II. Type II broken-gap superlattices

The Dawn of Thermoelectricity

Edmund Altenkirch, Phys.Zeits. **10**, 560 (1909); **12**, 920 (1911).

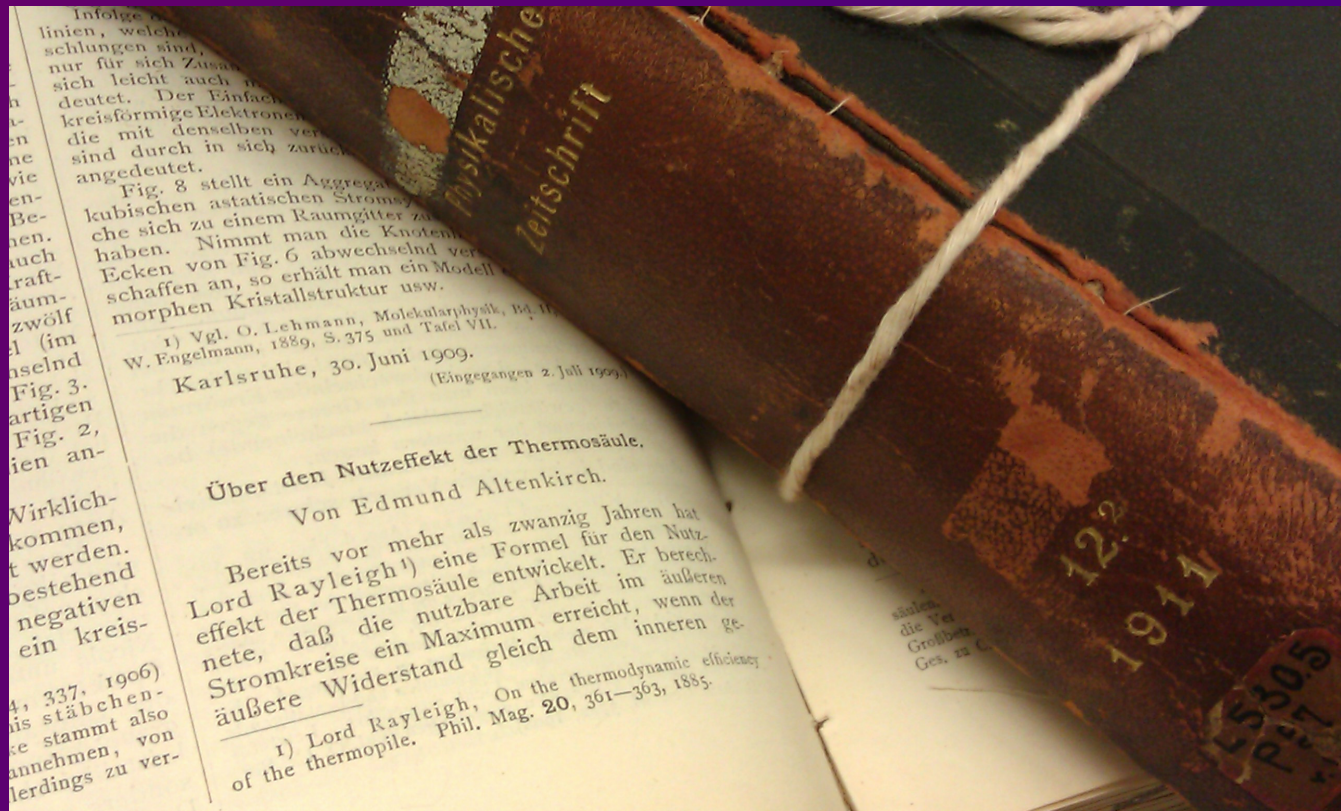


Figure of Merit

$$ZT = \frac{S^2}{\rho \kappa} T$$

INTENSIVE PARAMETERS

S – Seebeck coefficient

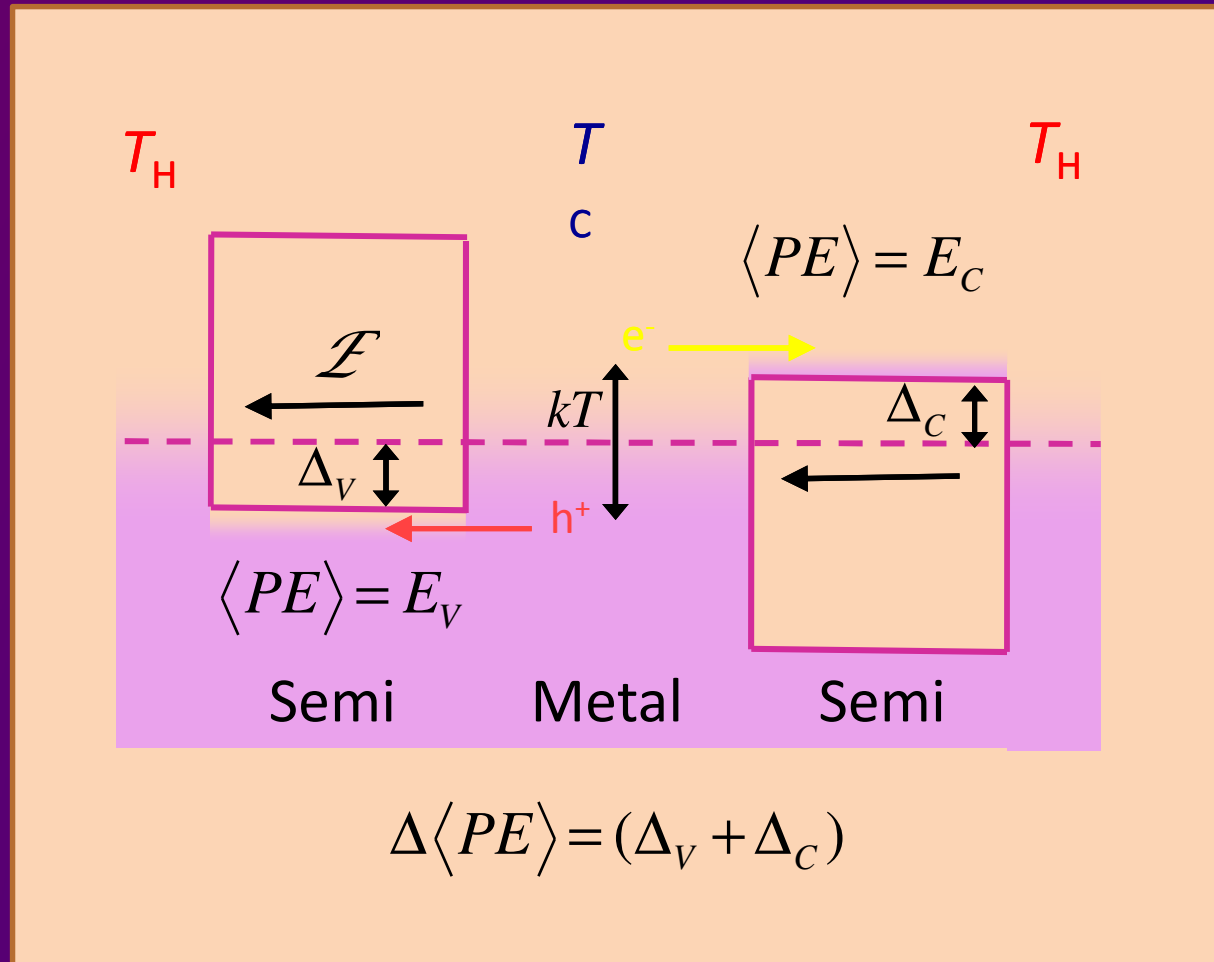
ρ – Electrical resistivity

κ – Thermal conductivity

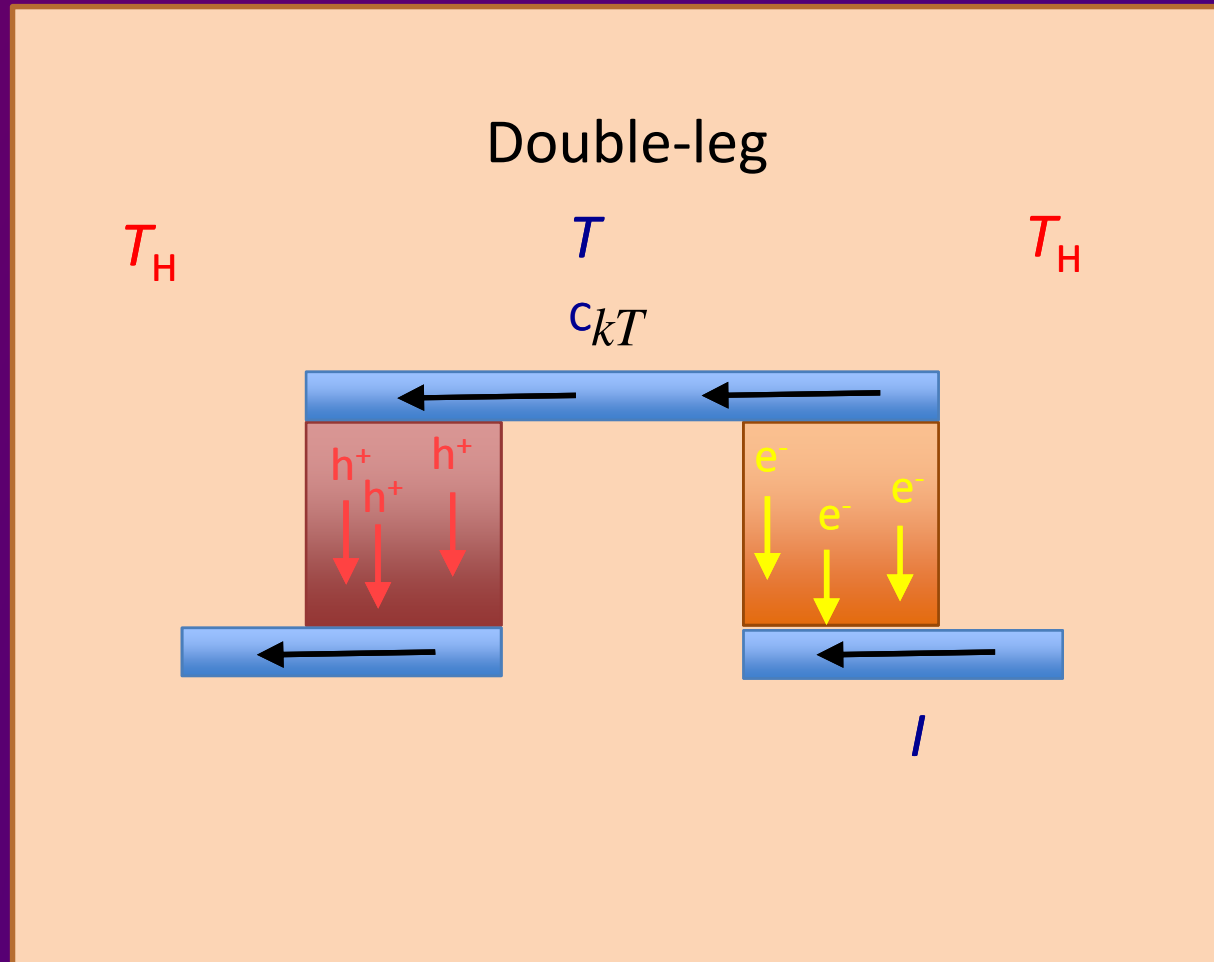
Longitudinal thermoelectric figure of merit:

$$Z_{\parallel} T = \frac{S_{xx}^2}{\rho_{xx} K_{xx}} T$$

Longitudinal Thermoelectric:



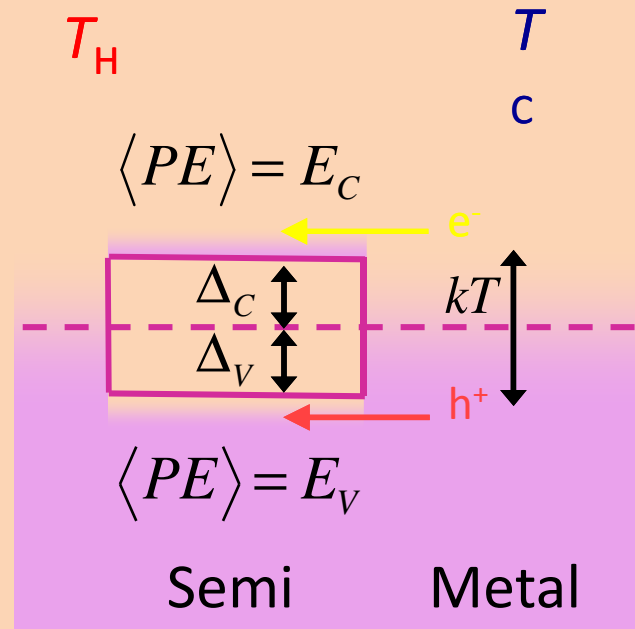
Longitudinal Thermoelectric:



Transverse thermoelectric figure of merit:

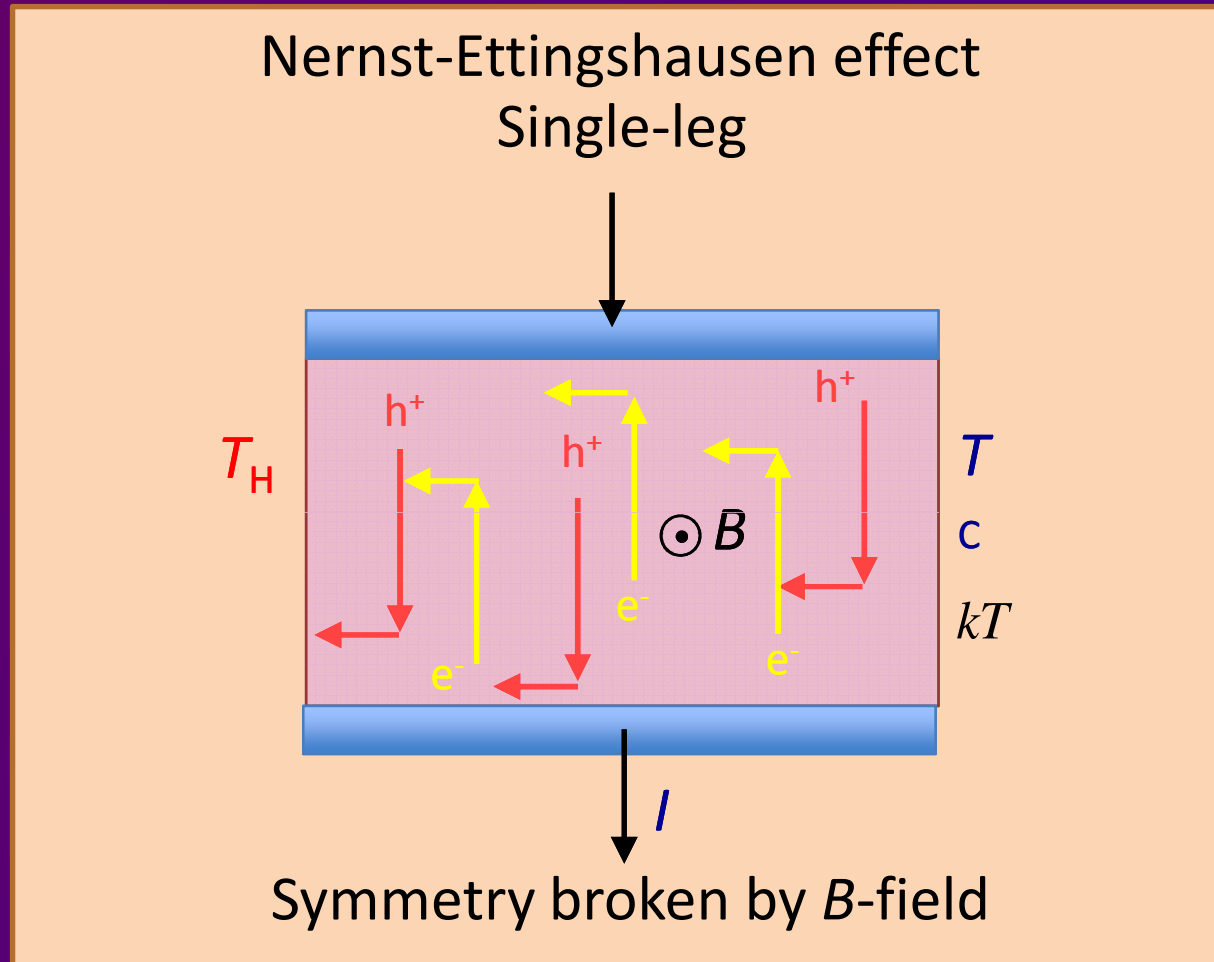
$$Z_{\perp} T = \frac{S_{xz}^2}{\rho_{xx} K_{zz}} T$$

Transverse Thermoelectric:



$$\Delta \langle PE \rangle = (\Delta_V + \Delta_C) = E_G$$

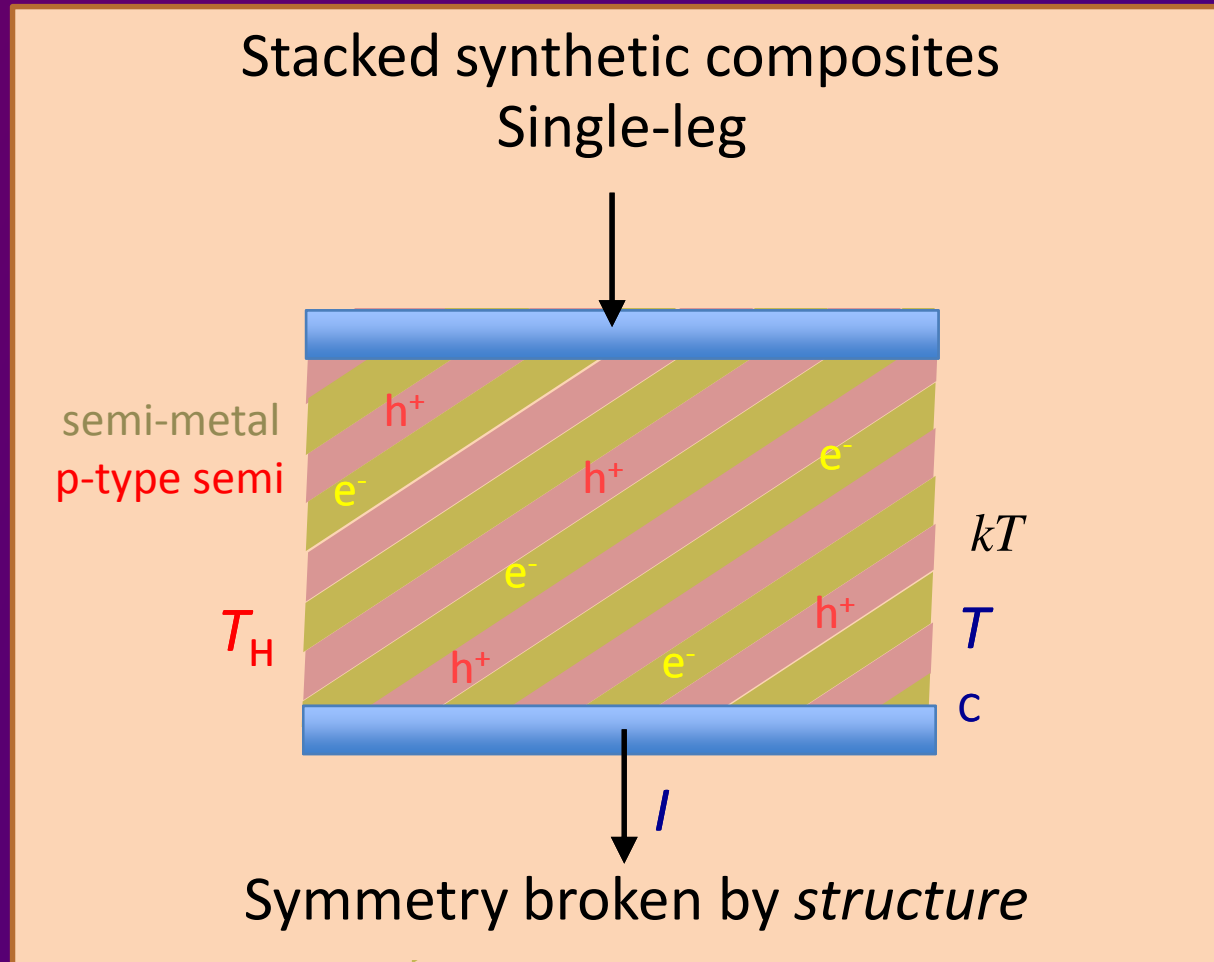
Transverse Thermoelectric:



DISADVANTAGE: REQUIRES LARGE B -field (1.5 T)

K.F. Cuff, Appl. Phys. Lett. 2, 145 (1963); C.F. Kooi, J. Appl. Phys. 34, 1735 (1963)

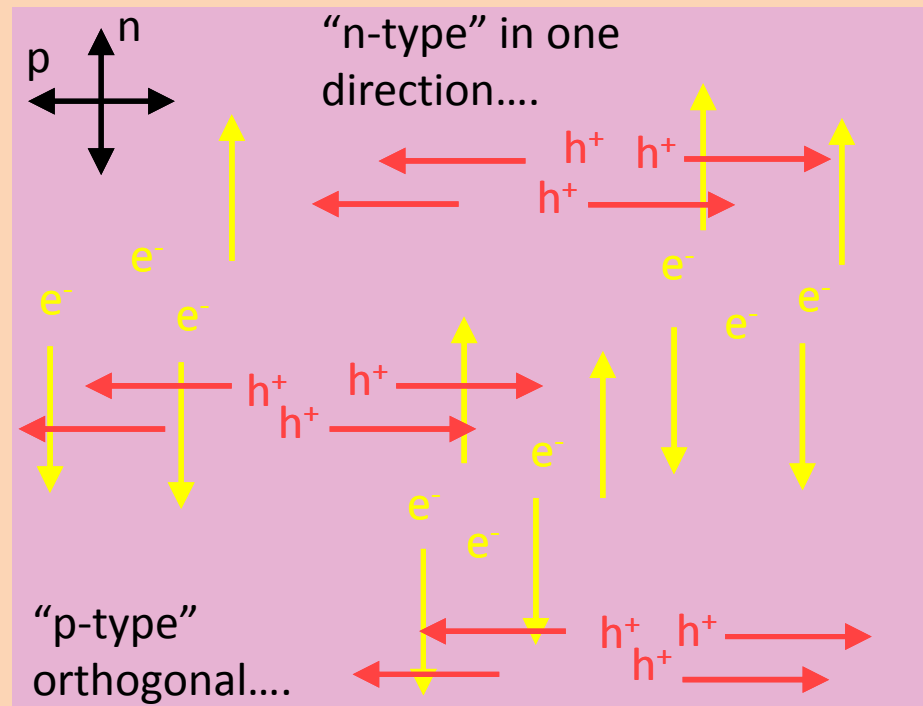
Transverse Thermoelectric:



DISADVANTAGE: Thick (\sim mm) layers cannot be scaled down
Labor intensive fabrication

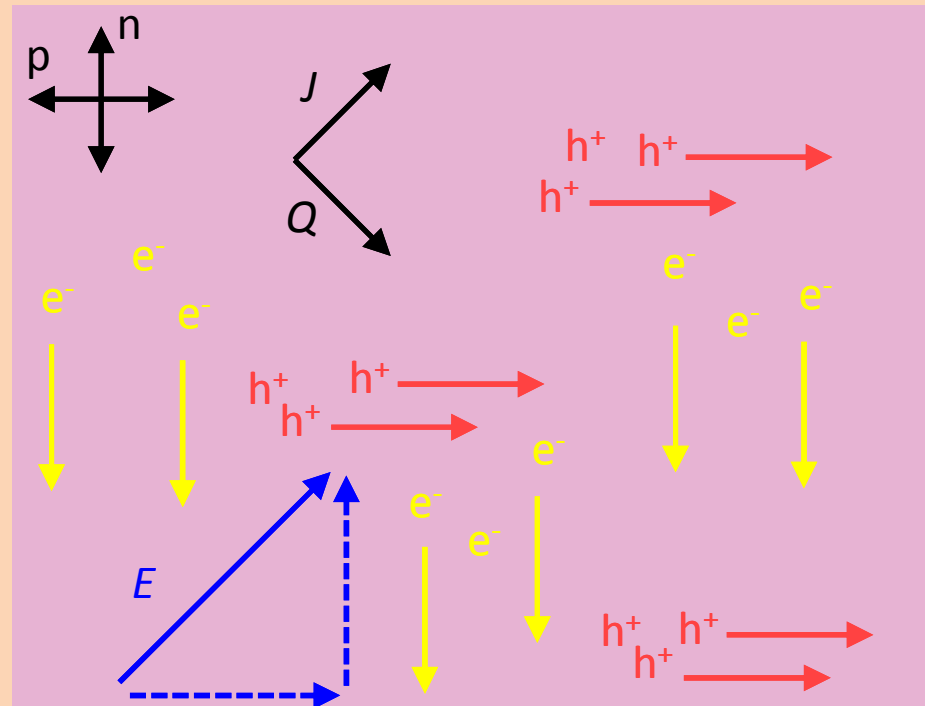
V.P. Babin, *Sov. Phys. Semicond.* 8, 478 (1974); Reitmaier, *Appl. Phys. A* 99, 717 (2010)

p x n Transverse Thermoelectrics



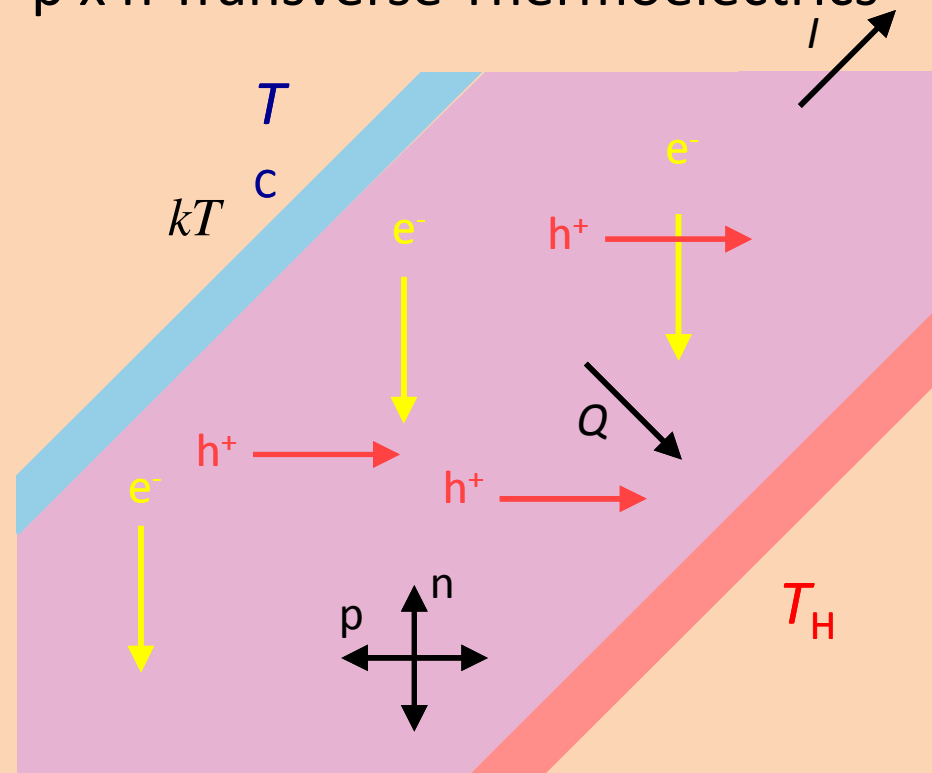
Symmetry broken by *band structure anisotropy*

p x n Transverse Thermoelectrics



Symmetry broken by *band structure anisotropy*

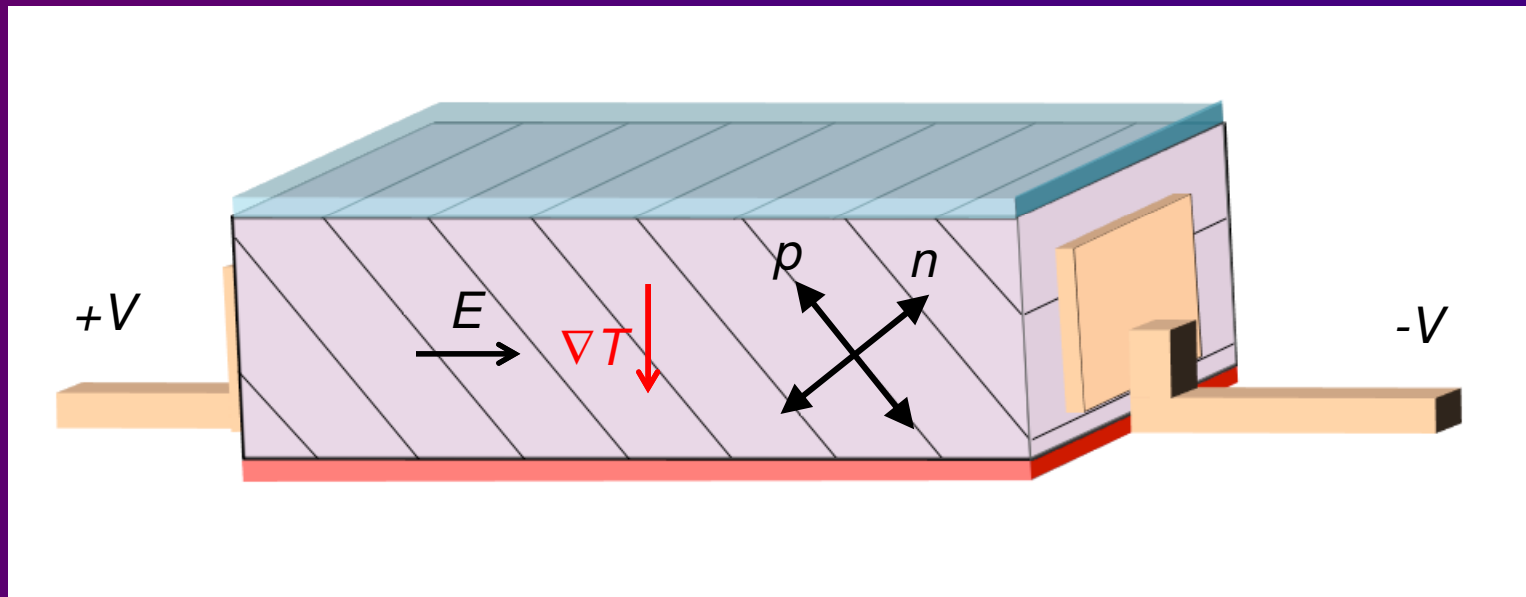
p x n Transverse Thermoelectrics



Symmetry broken by *band structure anisotropy*

ADVANTAGE: *Scalable to cm or μm*
No external B-field

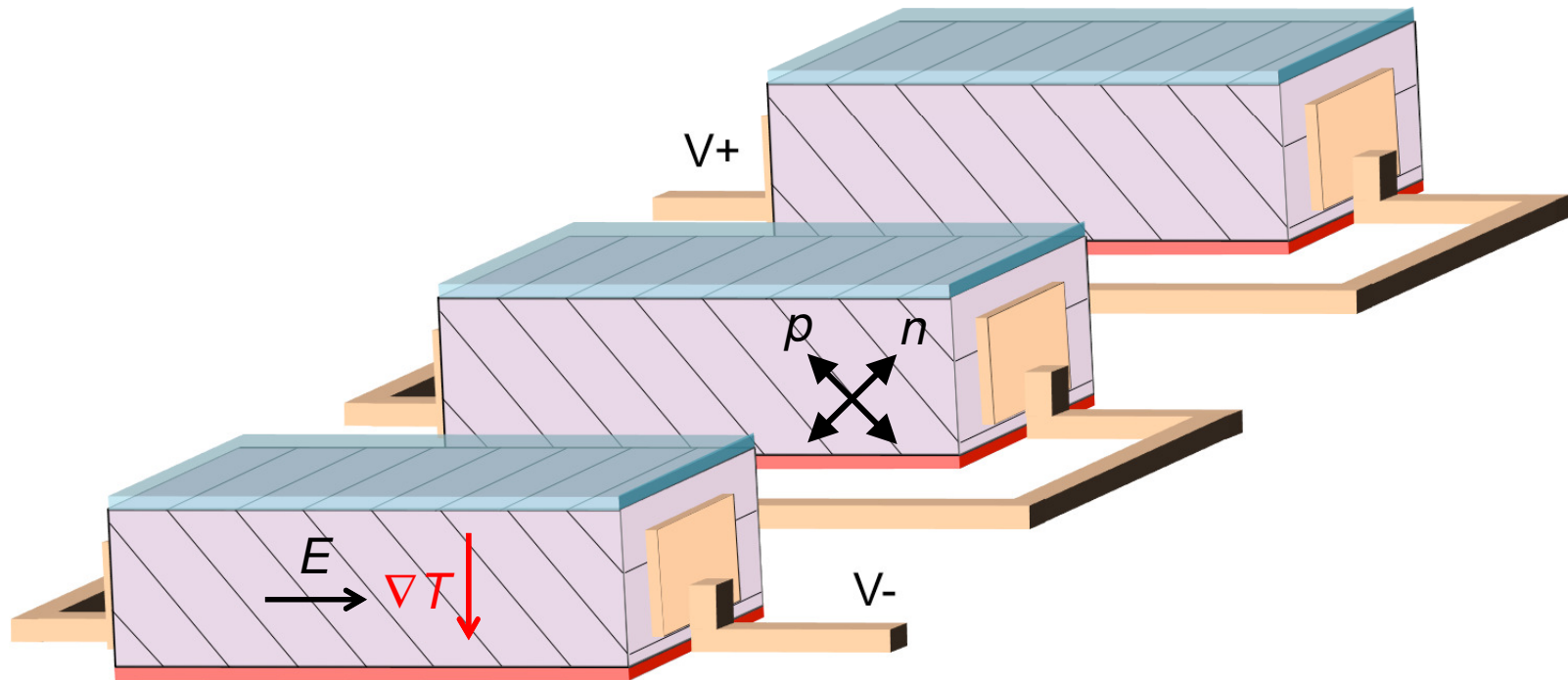
Transverse Seebeck voltage generator



Transverse Seebeck voltage generator

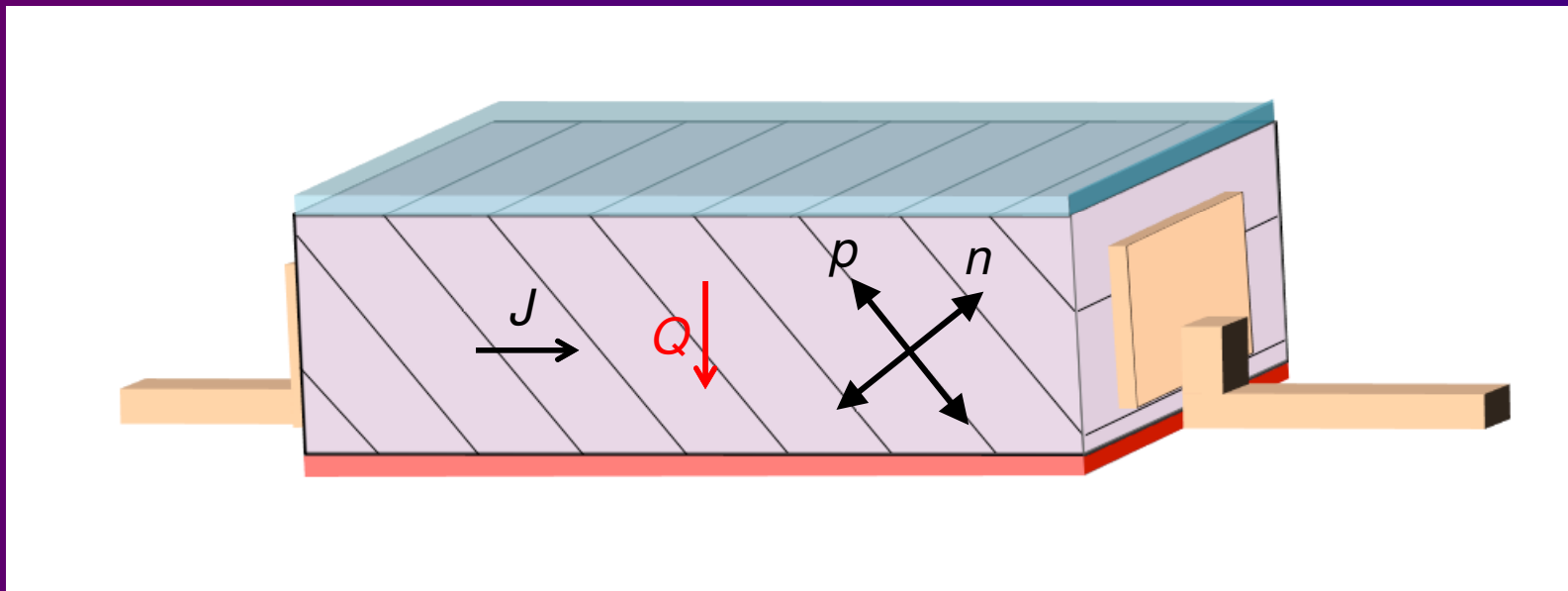
Meander structure:

Arbitrarily large Seebeck voltages V with small ΔT



H. J. Goldsmid, J. Elec. Mat.,40 5, 1254 (2010).

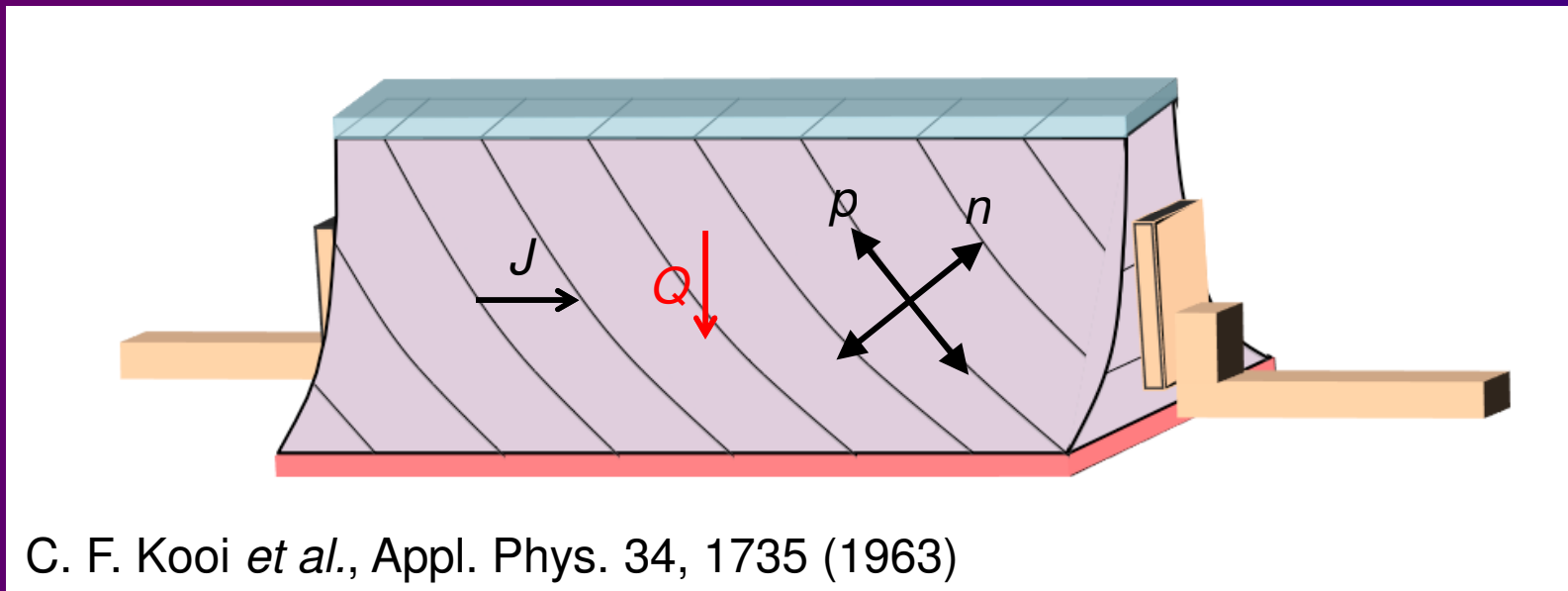
Transverse Peltier cooler



Transverse Peltier cooler

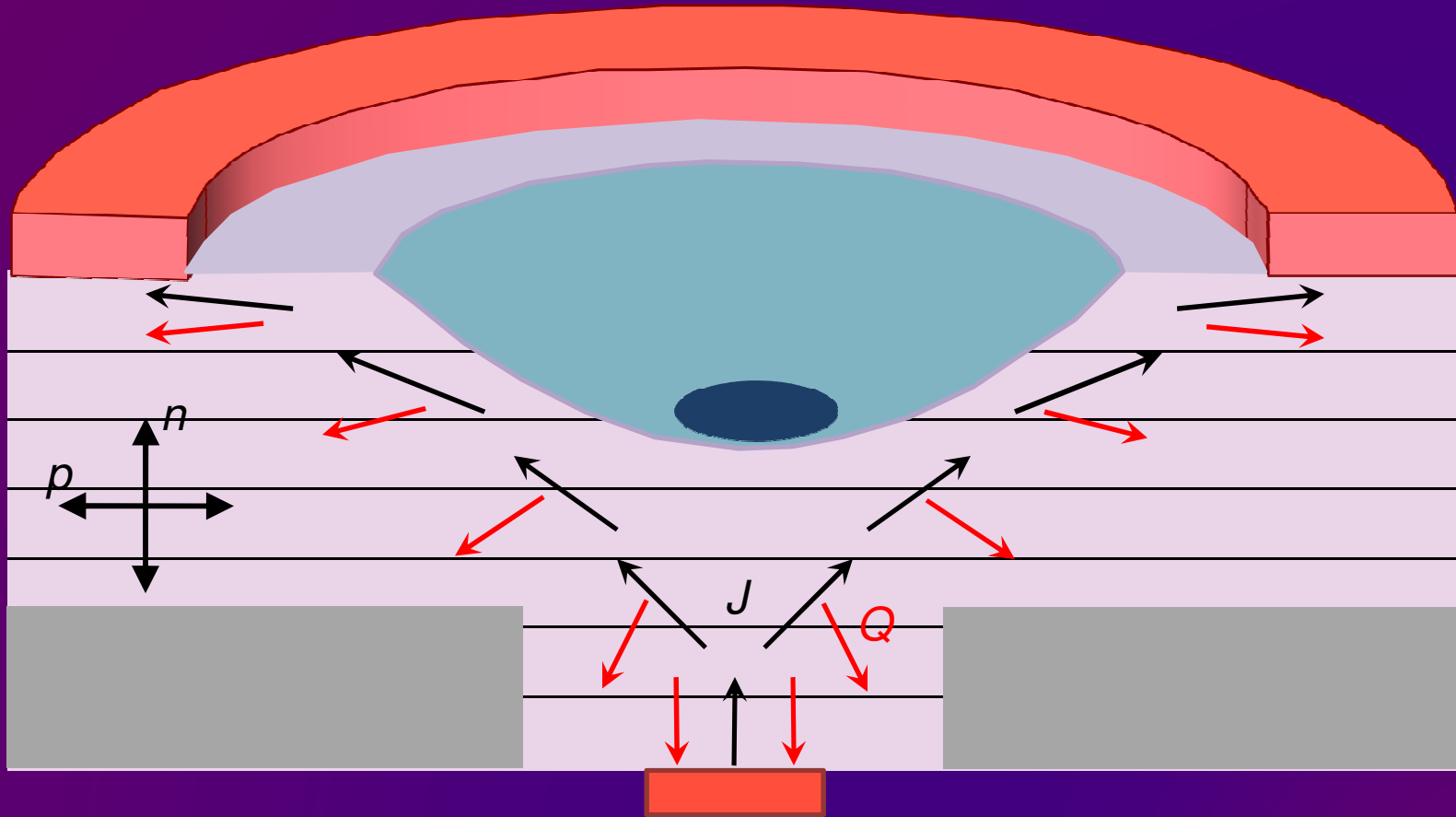
Exponential Taper:

Arbitrarily large ΔT with finite current J



Annular Peltier cooler

Every angle of current takes heat away from center



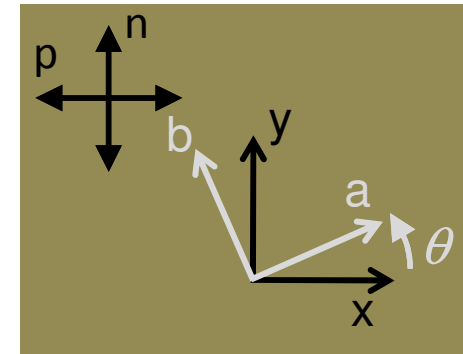
$p \times n$ Seebeck tensor

- Seebeck Tensor

$$\mathbf{s}_n = \begin{bmatrix} s_n & 0 \\ 0 & s_n \end{bmatrix}, \mathbf{s}_p = \begin{bmatrix} s_p & 0 \\ 0 & s_p \end{bmatrix}$$

- Electrical conductivity Tensor

$$\boldsymbol{\sigma}_n = \begin{bmatrix} 0 & 0 \\ 0 & \sigma_{n,yy} \end{bmatrix}, \boldsymbol{\sigma}_p = \begin{bmatrix} \sigma_{p,xx} & 0 \\ 0 & 0 \end{bmatrix}$$



- Total Seebeck Tensor

$$\mathbf{S} = (\boldsymbol{\sigma}_p + \boldsymbol{\sigma}_n)^{-1} (\boldsymbol{\sigma}_p \mathbf{s}_p + \boldsymbol{\sigma}_n \mathbf{s}_n)$$

$$\mathbf{S} = \begin{bmatrix} s_p & 0 \\ 0 & s_n \end{bmatrix}, s_p > 0, s_n < 0$$

$$\mathbf{S}' = \mathbf{R}_\theta^{-1} \begin{bmatrix} s_p & 0 \\ 0 & s_n \end{bmatrix} \mathbf{R}_\theta = \begin{bmatrix} s_{aa} & s_{ab} \\ s_{ba} & s_{bb} \end{bmatrix}$$

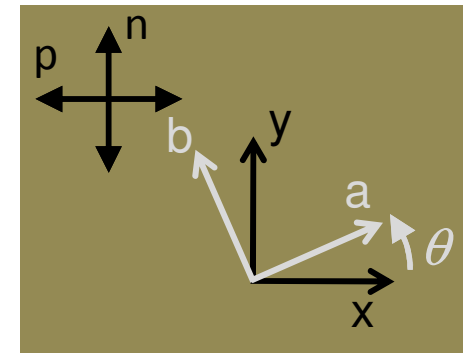
Optimal transport coefficients

- Optimal angle

$$\cos^2 \theta_{\perp} = \frac{1}{1 + \sqrt{\frac{\kappa_{yy} / \kappa_{xx}}{\rho_{yy} / \rho_{xx}}}}$$

- Optimal transverse figure of merit

$$Z_{\perp} T = Z_{ba}(\theta_{\perp}) T = \frac{(S_{p,xx} - S_{n,yy})^2 T}{\left(\sqrt{\rho_{xx} \kappa_{xx}} + \sqrt{\rho_{yy} \kappa_{yy}}\right)^2}$$



p x n Transverse Thermoelectrics:

Outline:

I. Transverse Thermoelectricity

II. Type II broken-gap superlattices

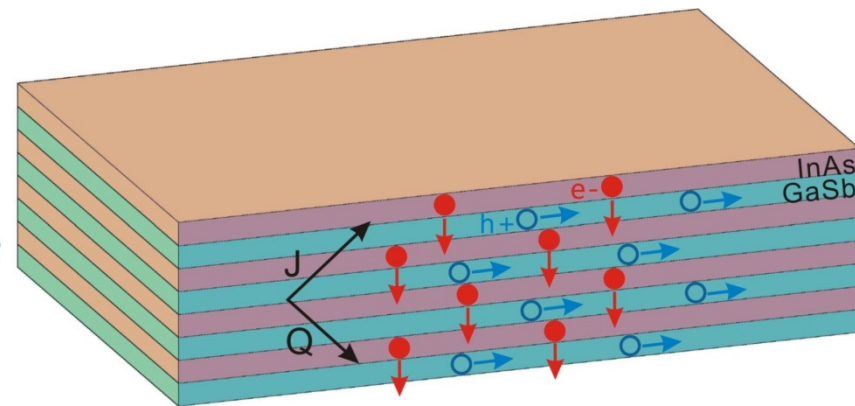
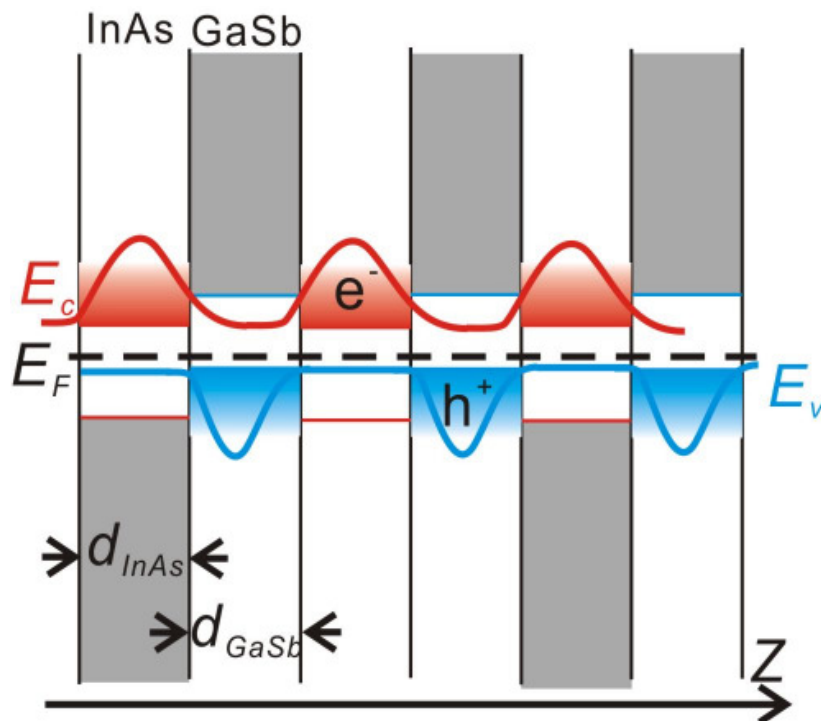
Transverse thermoelectric figure of merit:

$$Z_{\perp} T = \frac{S_{xz}^2}{\rho_{xx} K_{zz}} T$$

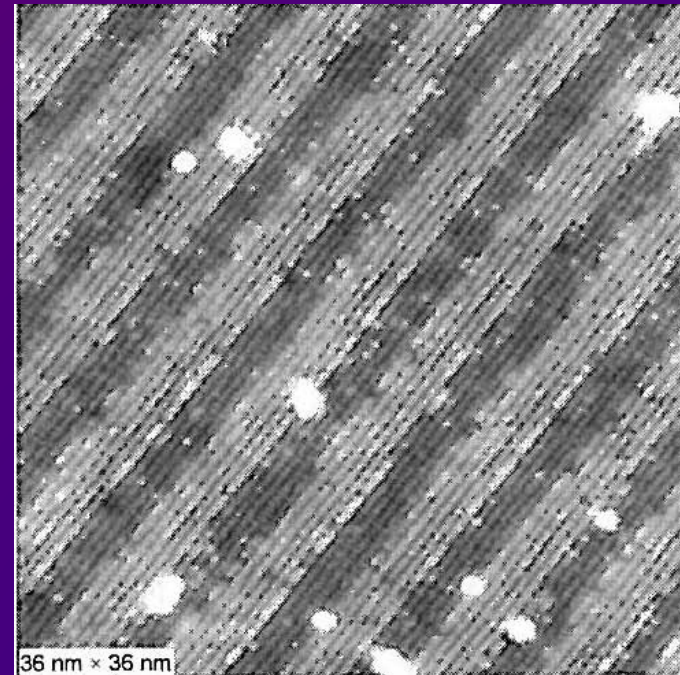
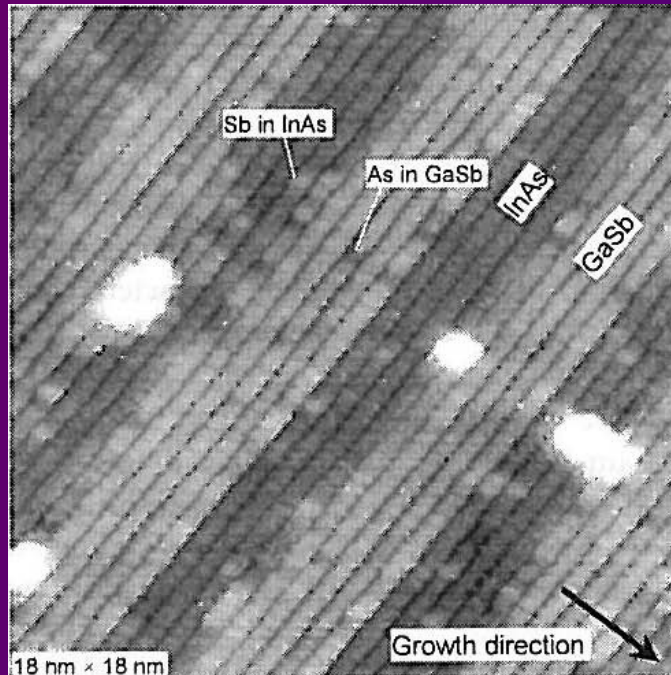


InAs/GaSb Type II superlattice

- InAs/GaSb type II broken-gap superlattice (T2SL)
 - Tunable bandgap
 - Anisotropic electron-hole transport
 - Fabrication challenge: strain, interface diffusion



Interface Quality:



Minimal Sb segregation
Up to 15 μm superlattice growth with smooth morphology

M. Razeghi, Binh-Minh Nguyen, et al.

Proc. SPIE **6206**, 0277-786X/06 (2006)

Type II superlattice photodetectors for MWIR to VLWIR Focal Plane Arrays

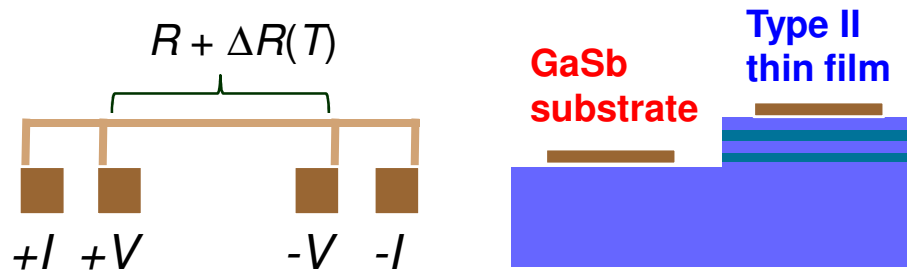
Thermal Conductivity: Experiment

$$Z_{\perp} T = \frac{S_{xz}^2}{\rho_{xx} K_{zz}} T$$



3 ω Thermal Conductivity

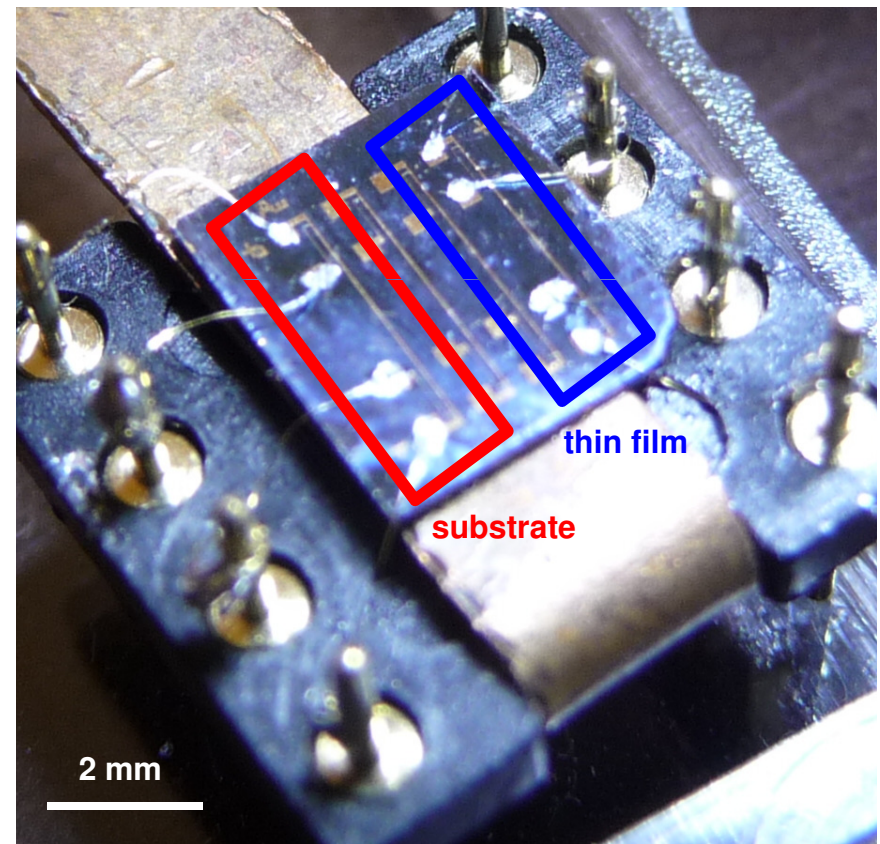
- Vertical thermal conductivity proportional to 3rd harmonic



$$K = \frac{V_{\omega}^3 \ln \left| \frac{f_1}{f_2} \right| e^{i\omega t}}{4\pi L R^2 (V_{3\omega,1}^3 - V_{3\omega,2}^3) e^{i2\omega t}} \frac{dR}{dT}$$

$$\Delta R \sim (dR/dT) T \sim e^{i2\omega t}$$

$$\Delta V = I \Delta R \sim \boxed{e^{i3\omega t}}$$



D. G. Cahill, Rev. Sci. Instrum. 61(2) 802, (1990).

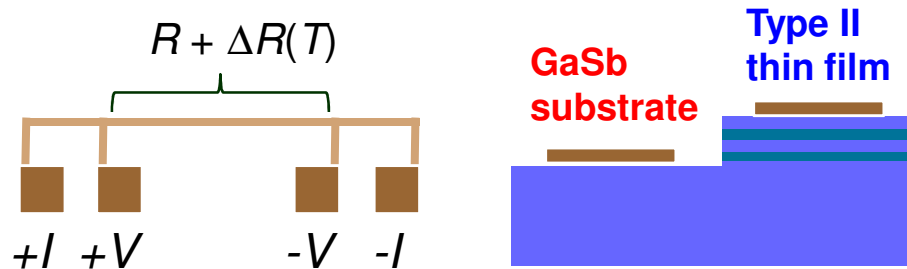
D. G. Cahill, Phys. Rev. B 50, 6077 (1994).

Chuanle Zhou, MG, et al. J. Elect. Mat. (2012)



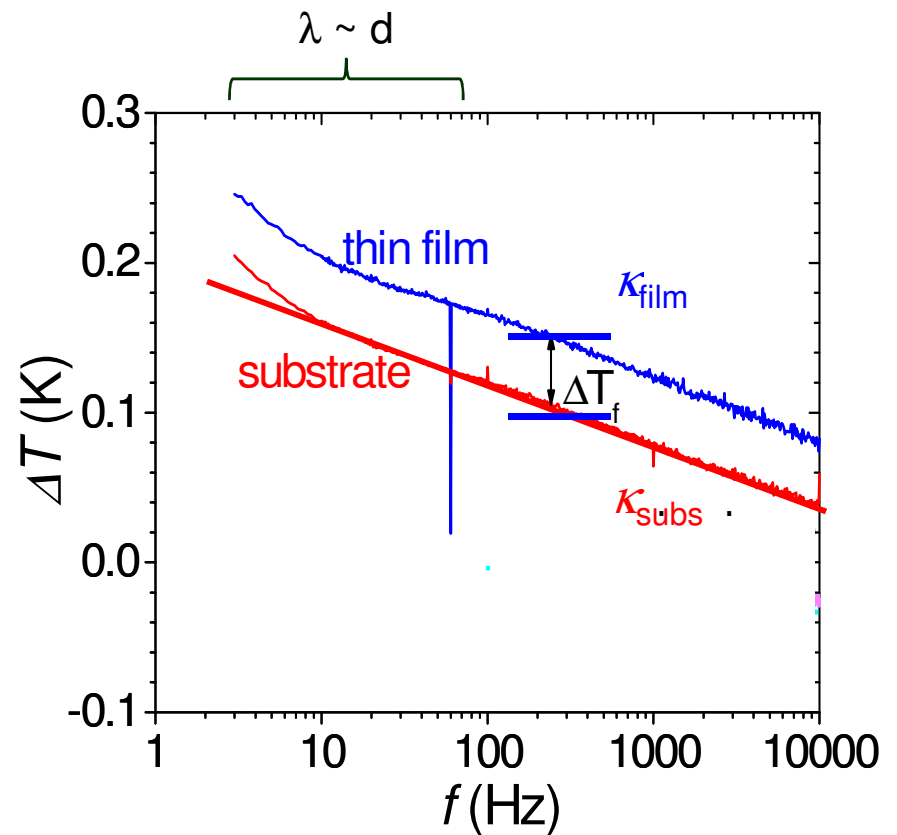
3 ω Thermal Conductivity

- Vertical thermal conductivity proportional to 3rd harmonic



$$\kappa = \frac{V_{\omega}^3 \ln|f_1/f_2|}{4\pi L R^2 (V_{3\omega,1} - V_{3\omega,2})} \frac{dR}{dT}$$

$$\Delta V = I \Delta R \sim \boxed{e^{i3\omega t}}$$



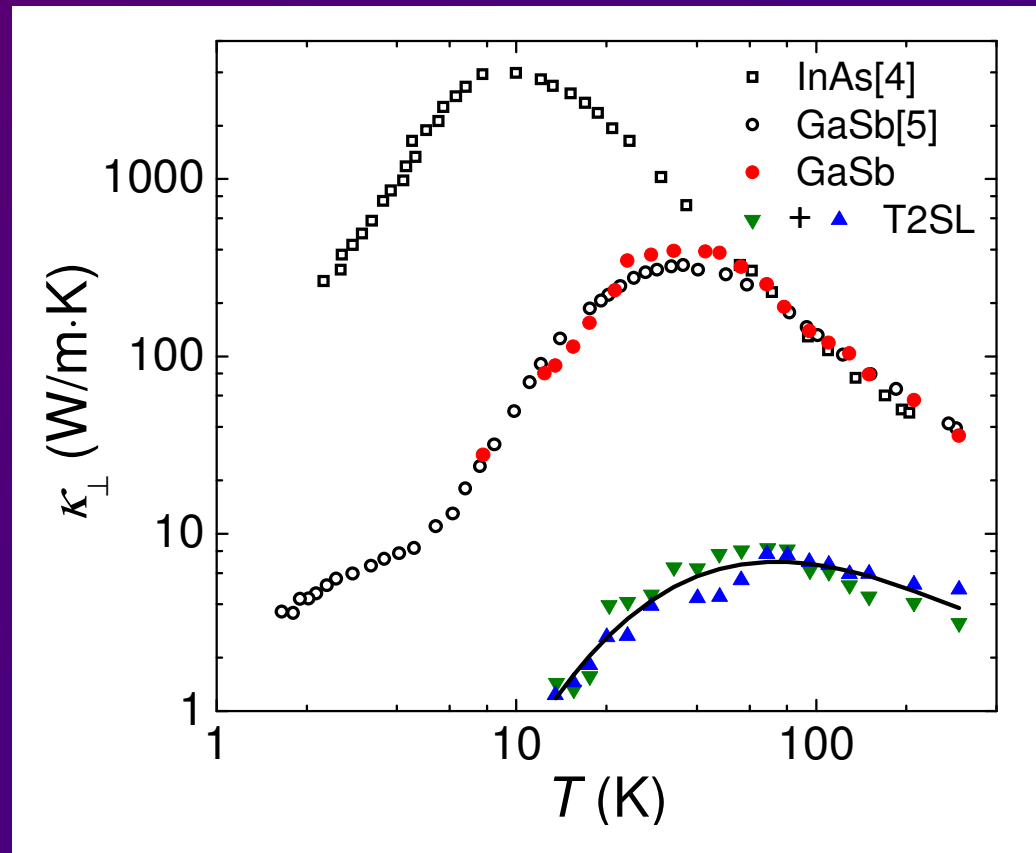
D. G. Cahill, Rev. Sci. Instrum. 61(2) 802, (1990).

D. G. Cahill, Phys. Rev. B 50, 6077 (1994).

Chuanle Zhou, MG, et al. J. Elect. Mat. (2012)

Type II Superlattice Thermal Conductivity

Thermal conductivity suppressed up to 2 orders of magnitude from GaSb bulk value



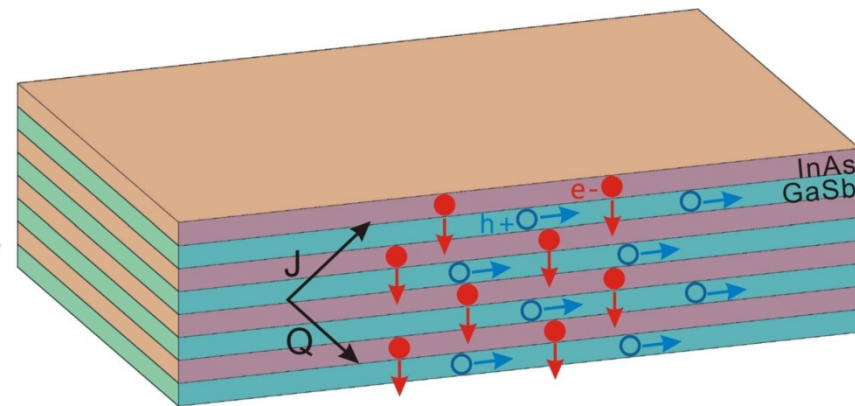
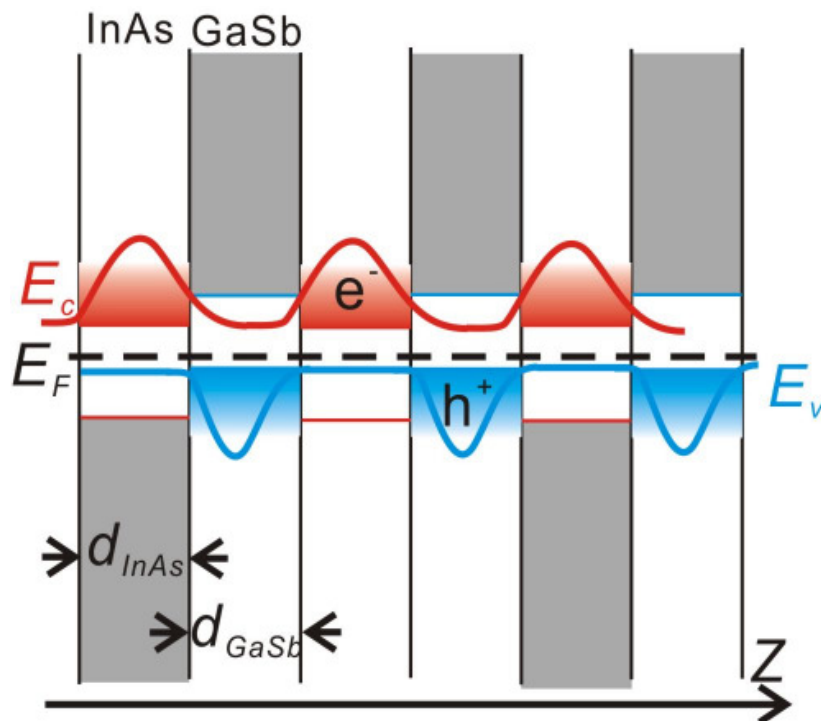
Power Factor: Theory

$$Z_{\perp} T = \frac{S_{xz}^2}{\rho_{xx} K_{zz}} T$$



InAs/GaSb Type II superlattice

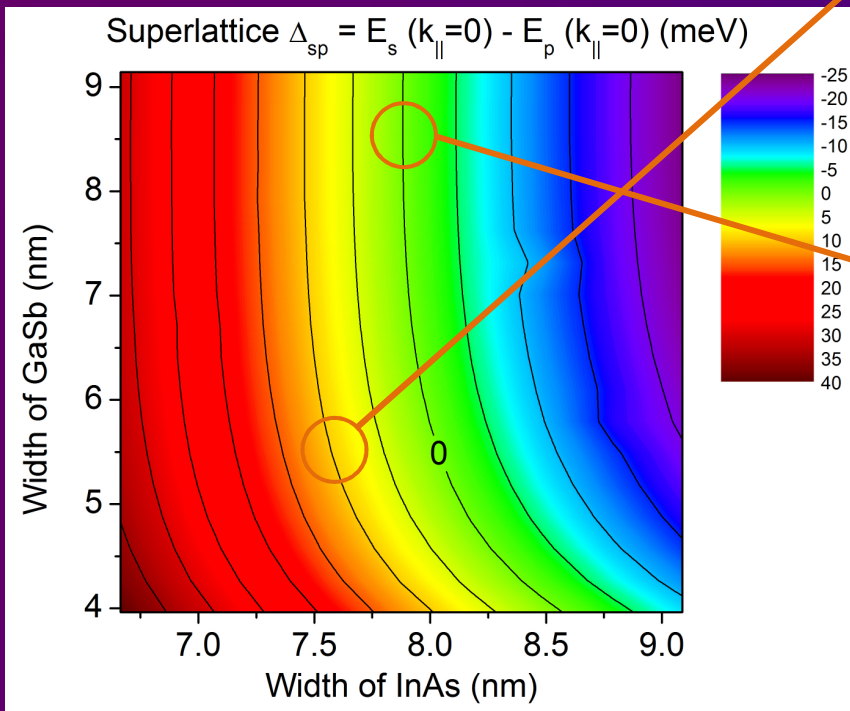
- InAs/GaSb type II broken-gap superlattice (T2SL)
 - Tunable bandgap
 - Anisotropic electron-hole transport
 - Fabrication challenge: strain, interface diffusion



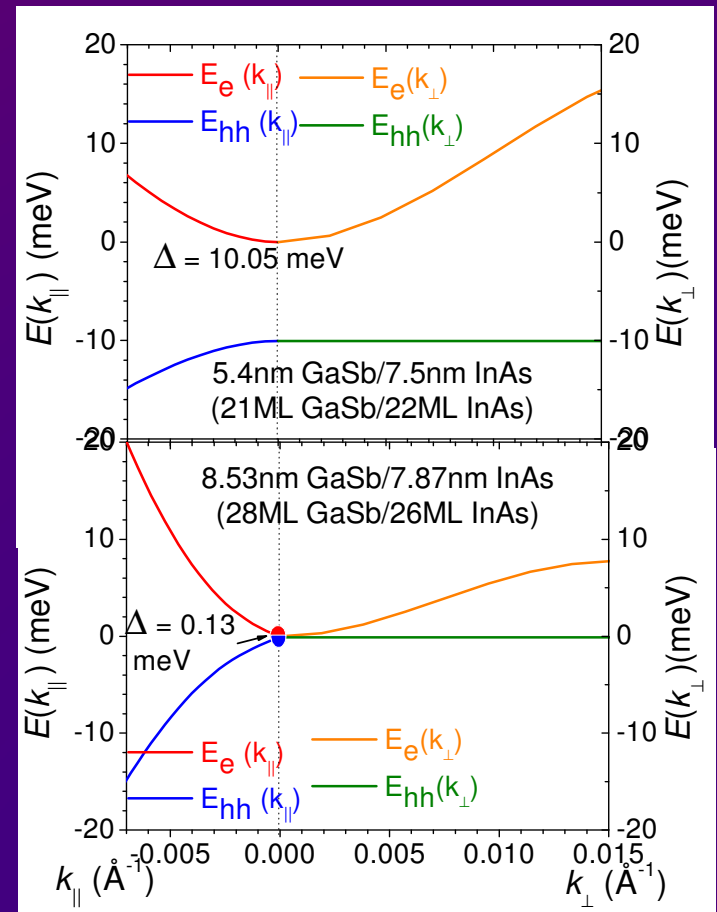
Type II Superlattice

*NextNANO*³: Full-band envelope-function simulation InAs/GaSb superlattice dispersion

Positive gap:
Semiconductor



Zero gap





Deduce Conductivity & Seebeck Tensor

From band structure => $m_{n,x}, m_{n,y}, m_{p,y}, E_g$ ($m_{p,y} = \infty$)

For n -conductivity & Seebeck:
anisotropic 3D dispersion

$$\sigma_{n,xx} = \frac{2\sqrt{2}e^2\gamma}{3\pi^2\hbar^3} \sqrt{m_{n,y}} (k_B T)^{s+3/2} \Gamma\left(s + \frac{3}{2}\right) F_{3/2+s}\left(\frac{\mu - E_g}{k_B T}\right),$$

$$\sigma_{n,yy} = \frac{2\sqrt{2}e^2\gamma}{3\pi^2\hbar^3} \sqrt{\frac{m_{n,x}^2}{m_{n,y}}} (k_B T)^{s+3/2} \Gamma\left(s + \frac{3}{2}\right) F_{3/2+s}\left(\frac{\mu - E_g}{k_B T}\right)$$

$$s_n = \frac{-k_B}{e} \left[\frac{(s+5/2) F_{s+3/2}\left(\frac{\mu - E_g}{k_B T}\right)}{(s+3/2) F_{s+1/2}\left(\frac{\mu - E_g}{k_B T}\right)} - \frac{\mu - E_g}{k_B T} \right]$$

For p -conductivity & Seebeck:
2D dispersion

$$\sigma_{p,xx} = \frac{e^2\gamma}{\pi d\hbar^2} (k_B T)^{s+1} \Gamma(s+2) F_{1+s}\left(\frac{-\mu}{k_B T}\right)$$

$$\sigma_{p,yy} = 0$$

$$s_p = \frac{k_B}{e} \left[\frac{(s+2) F_{s+1}\left(\frac{-\mu}{k_B T}\right)}{(s+1) F_s\left(\frac{-\mu}{k_B T}\right)} + \frac{\mu}{k_B T} \right]$$

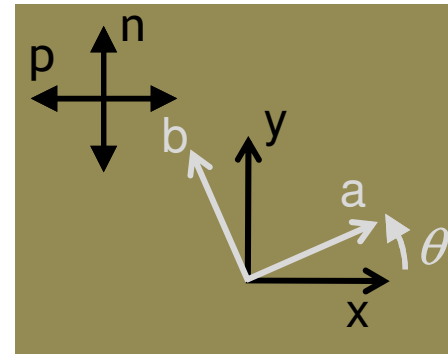
(Power-law scattering, $\tau = \gamma E^s$, where $s = 0$ observed for T2SL at 300 K)

Optimize transverse power factor $S^2\sigma$ => deduce optimal chemical potential μ

INAS/GASB TYPE II SUPERLATTICE

○ Optimal T2SL

- $d_{\text{GaSb}} = 3.96 \text{ nm}$, $d_{\text{InAs}} = 7.88 \text{ nm}$
- $E_g = 28.3 \text{ meV}$, $\mu = 2.43 \text{ meV}$
- $\theta_{\perp} = 32^{\circ}$
- $\kappa = 4 \text{ W/m}\cdot\text{K}$ (measured¹)
- $Z_{\perp} T = 0.025$ at $T = 300 \text{ K}$





Differential Transport Equations

- Transverse Thermoelectrics

$$0 = \left(\frac{E_a}{S_{ba}} - \frac{dT}{db} \right)^2 + \frac{(1 + Z_{ba}T)}{Z_{ba}} \frac{d^2T}{db^2}$$

$$S_{ba} = S_{ab}$$

- Longitudinal thermoelectrics

$$0 = \left(\frac{E_a}{S_{ba}} \right)^2 + \frac{1}{Z} \frac{d^2T}{db^2}$$

$$S_{ba} = S_{ab} = 0$$

- Ettingshausen effect

$$0 = \left(\frac{E_a}{S_{ba}} \right)^2 - \left(\frac{dT}{db} \right)^2 + \frac{(1 - Z_{ba}T)}{Z_{ba}} \frac{d^2T}{db^2}$$

$$S_{ba} = -S_{ab}$$



Thermal distribution

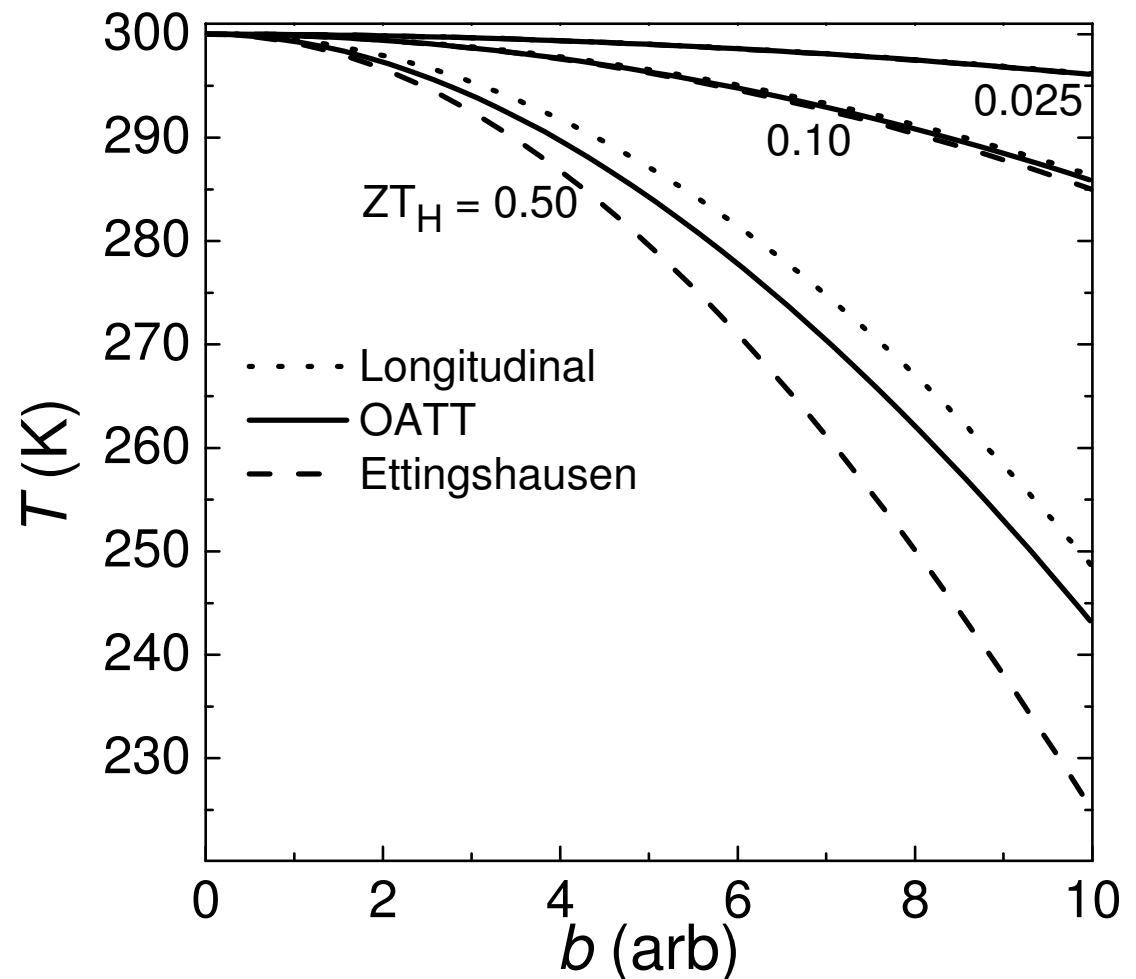
- Different from longitudinal and Ettingshausen cooling

■ $\Delta T = 4$ K ($ZT = 0.026$)

$T_H = 300$ K, $b = 10$ μm

$\Delta T = 14$ K ($ZT = 0.1$)

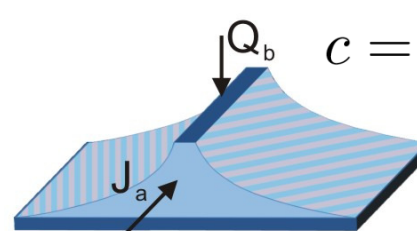
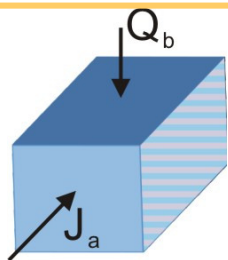
$\Delta T = 56$ K ($ZT = 0.5$)





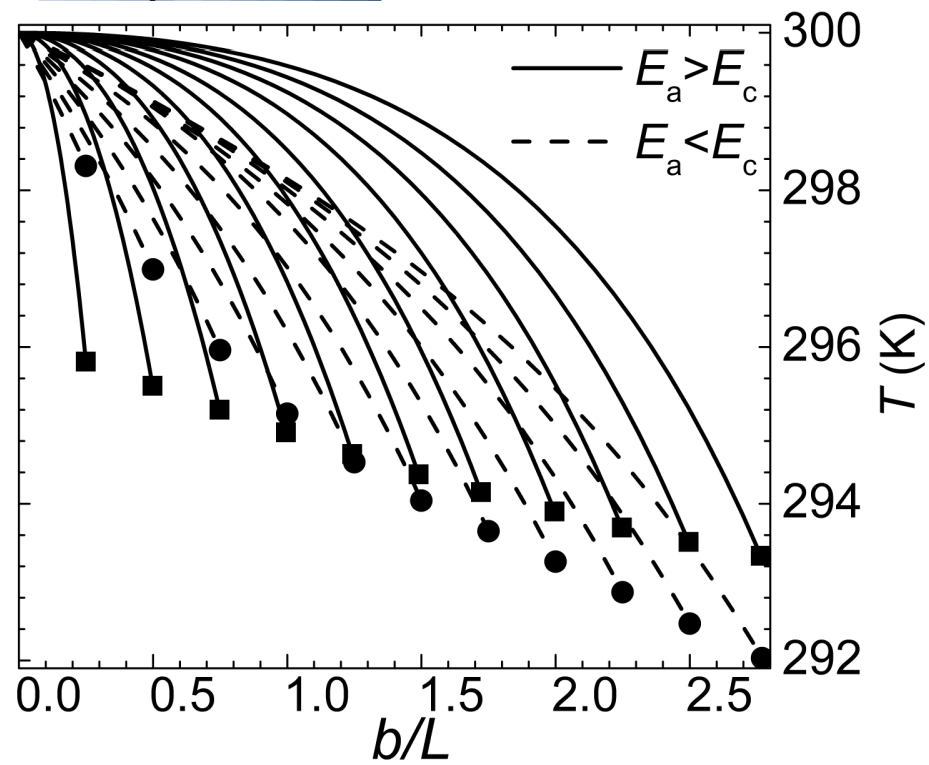
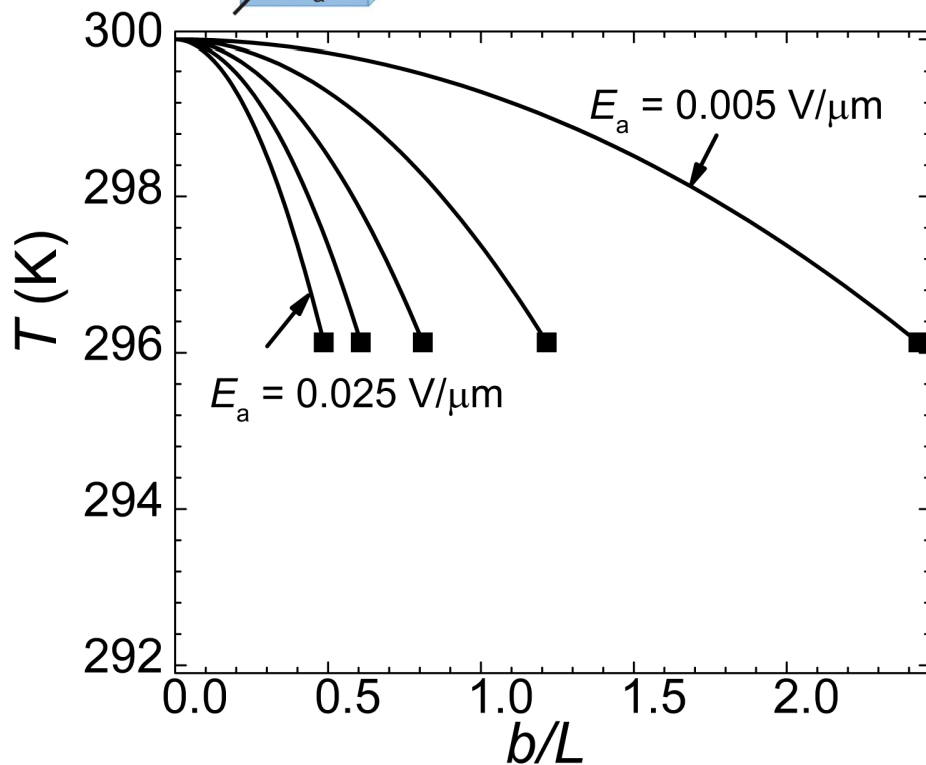
Exponentially tapering

- A competitive $\Delta T = 8 \text{ K}$ ($b/L=2.77$)



$$c = c_0 e^{-(b/L)}$$

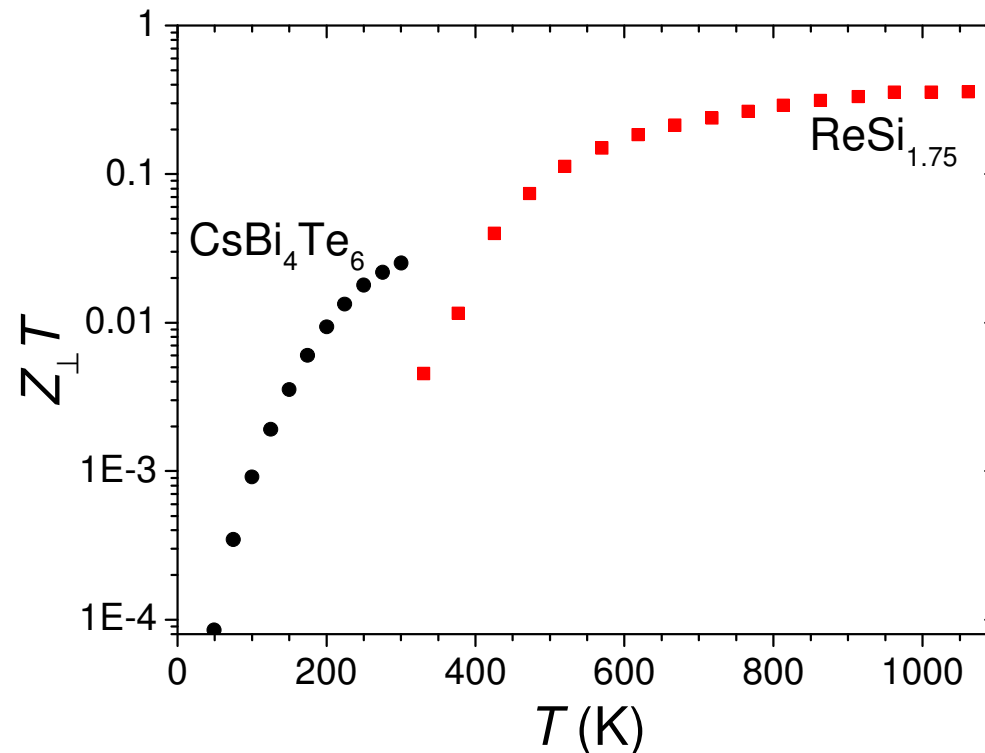
$$E_c = -\frac{S_{ba} T_H}{L}$$





$p \times n$ Type material

- Bulk materials (monoclinic)^{1,2}: CsBi_4Te_6 , $\text{ReGe}_x\text{Si}_{1.75-x}$
 p -type in a -direction and n -type in c -direction



- Bulk material, geometric shaping
- Low $Z_{\perp} T$ at low temperature

¹Gu, Zhang, PRB 71, 113201 (2005)

²Chyung, Mahanti, Kanatzidis,
MRS Proc 793 (2004)

p x n Transverse Thermoelectrics:

Outline:

- I. Transverse Thermoelectricity
- II. Type II broken-gap superlattices

Let Us Meet Again

We welcome all to our future group conferences
of Omics group international

Please visit:

www.omicsgroup.com

www.Conferenceseries.com

<http://optics.conferenceseries.com/>